

CONTEC www.contec.com

#### ~ Distributed Monitoring & Control Network ~

# F&ell Solution

### Micro Controller

- **Highly Reliable and Easily Maintained**
- Olltra Compact Design provides easy on-site installation



Able to run on various operating systems, such as Windows® and Linux, this micro computer is ideal for use in a number of applications. It's compact size makes it perfect for use as an embedded controller in areas where there is limited space.

[ Micro Controller ] P.04/05

- Low voltage, fanless CPU
- No HDD Uses Compact Flash
- Supported OS Windows® 2000/XP/XP embedded, PC DOS 2000, Linux
- Interfaces include USB2.0, RS-232C, Gigabit LAN
- Easy application development through the use of included software





[ I/O Controllers ] **P.06/07** 

### I/O Controller

- © Ethernet-based Remote I/O
- Can be installed using existing ethernet cables

This I/O controllers are ideal when configuring an ethernet-based Remote I/O system. When used remotely, they provide effective monitoring and control from throughout the installation. Expand functions on an as-needed basis using Contec's varied selection of device modules.

\*Up to 8 device modules (max) can be connected to the I/O controller

\* USB-based Remote I/O Systems also available

Fan-less, compact design

 Remote I/O control from Windows PCs, socket function programs

 Simple application development by using included software



# **CONTEC** offers a variety of server modules to fit a wide range of applications

I/O Assist Server

 For integrated management & remote monitoring of I/O Controller Unit

P.16



Micro Portable Embedded Firewall / Router

These servers enable remote monitoring via both

wired and wireless networks. Using standard

Ethernet protocols they are easily integrated into

P.18



#### Monitoring & Control Server

Program-less, Remote Monitoring & Control

P.17



existing systems.

### PLC Link Server

Remote PLC management via Intranet/Internet

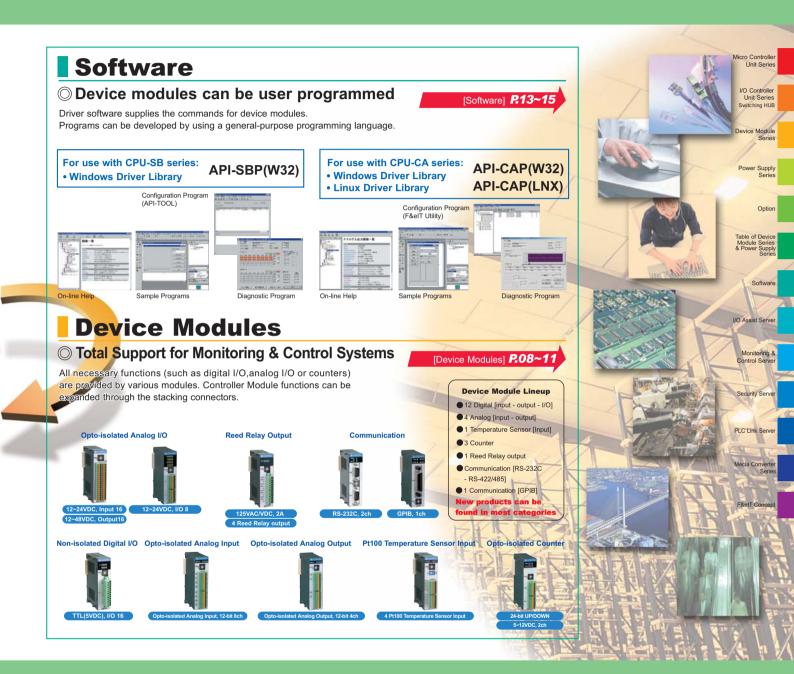


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# Space-saving Controllers & Device Modules A Flexible and Reliable Solution

Micro-computers and space-saving remote I/O offer ideal solutions for monitoring, measurement and control applications.

CONTEC's F&eIT remote I/O systems are flexible and reliable. They offer a space-saving alternative that is easily maintained and easily expandible.









### Micro Controller CPU-SB30 Series

O Ultra-compact, general-purpose PC. Supports Windows<sup>®</sup>, PC DOS 2000 and Linux.



\*1 The end-user can install Windows XP® or Windows 2000® SP3/SP4 on the CPU-SB303 by using a third-party USB CD -ROM or FD drive. Other operating systems can be installed if the USB drive is supported with the OS startup disk.

The CPU-SB30 can serve as either a general-purpose PC or a device controller for the CONTEC F&eIT series. It can run under various operating systems including Windows® XP. Built over a 852GM chipset its features include a Celeron M CPU, 512MB memory, USB2.0 and 1000 BASE-T ethernet. For expanded functionality F&eIT device modules can be connected via the stacked connector. The CPU-SB30 utilizes a heat sink for naturally air-cooled operation.

The CPU-SB30 features more advanced functions and is about 6 times faster than the previous microcontroller (CPU-SB20).

#### Micro Controller - CPU-SB30 Series

CPU-SB303-FIT-3F

ntel® Celeron M 800MHz CPU

CPU-SB303-FIT

#### Compact Flash (Optional)

CF-1GB

CF-512MB

\* 2: No operating system installed

#### CD/DVD-ROM Drive (Optional)

IPC-CDD-03

IPC-CDC-03

+ 3: Connection cable [IPC-CDC-03] is required

### Windows® XP Embedded Pre-installed [CPU-SB303-FIT-3F]

Windows® XP Embedded specifications are based on having Windows® XPe pre-installed on the CPU-SB303-FIT. With this, Windows® based applications can be easily configured.

■ Enhanced Write Filter function installed. Secure design allows Power Off' at any time

Writing control via the Enhanced Write Filter ("EWF") and Page File support eliminates the need for shutdown processing when turning the power OFF The result is a stable system that eliminates the concern of damaged file

Win32 API and Windows® XP applications fully supported Like Windows® XP Professional Windows® XP Embedded is a binary configured OS and fully supports Win32 API. Windows® XP-supported application resources can be fully accessed by using programs such as VisualStudio for development.

Windows® XP Embedded Custom configuration (For individual application customization, contact your local CONTEC office.)

Storage device

:2 GB Compact Flash

C drive(OS area: FAT32): OS use: 683 MB, free space: 1.22 GB, EWF

setting OFF (ON during unit operation)

EWF area :6 MB

• For details, please visit our website.

Power supply optional [Power Supplies] P.11

#### Software

#### Windows device module access library API-SBP(W32)

· Supported - all device modules

The API-SBP(W32) drivers provide commands for stacked Device Modules in Windows-standard Win32API(DLL) format. Programs can be developed in various programming languages that support Win32API (e.g. Visual Basic and Visual C++).

· Compatible with driver library API-PAC(W32) developed for CONTEC interface modules Latest driver versions can be downloaded free from CONTEC's Web site.

[Software] P.13

Included on CD-ROM

Micro Controlle Unit Series

#### **Compact Space-saving Design**

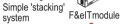
The functionality and expandability of a standard PC are all contained in a compact 94 mm (h) x 64.7 mm (d) module. This micro cocomputer can be run on a variety of standard operating systems.



One-touch operation for easy installation and removal

Interconnection of Device Modules





Bus connector Safety lock

#### **Easily Maintained / Industrially Sound**

This disk-free, fanless micro computer can be mounted on a 35mm DIN rail. It features a watchdog timer - essential for monitoring the health of industrial systems. All connections (excluding F&eIT bus) are located on the front side of the unit for ease of use.

#### **Outstanding Functions**

· The compact flash (or micro drive) is bootable and recognized as the C drive allowing standard computer operating systems and programming languages to be supported.

• I/O interfaces are expanded by connecting one of a wide range of device modules. Its unique interconnection mechanism allows device modules to be 'stacked' side-by-side so that additional interface components, such as backplanes, are not needed.

• 2 USB ports can be used for external CD-ROM, FDD, HDD, keyboard or other USB supported device.

#### **Application Example**

#### In confined areas with limited power



The unit can fit into spaces too small for standard PCs. In addition, using CONTEC's wireless LAN Micro Access Point allows you to embed this unit in mobile hardware or areas where wiring would be difficult. It is ideal for areas with limited power.

## Application 2 Example As a compact controller for I/O control systems Sensor

Side view

Through the use of the Device Module, these can be used as compact controllers supporting a variety of I/O or as a programmable ethernet-based remote I/O system.

[Device Modules] P.08~11



Item		Specificaion	CPU-SB303-FIT CPU-SB303-FIT-3F		
	PU		Ultra Low Voltage Intel® Celeron® M Processor 800MHz (FSB400MHz)		
	hip Set		Ona Low Vollage Intel® 652GM + ICH4 Intel® 852GM + ICH4		
	IIIp Set	L2 Cache	-		
N	lemory	Main Memory	512MB. 200-pin SO-DIMM socket×1. PC2100 (DDR266) DDR SDRAM		
10	icinory	BIOS ROM	STERRIE, 200-PINT 50-DINNIN SOCKER T, FG2 T00 (DDIX 200) DDIX 3DTXINI 4MB		
		Controller	Built in Intel® 852GM		
		Video RAM	Built in Hieles 622GW System memory shared (64MB max)		
\	'ideo	Video BIOS	48KB (C0000H - CBFFFF)		
		CRT I/F	Analog RGB I/Fx1 (15-pin HD-sub connector×1)		
		ORT III	640×480, 800×600, 1024×768, 1152×864, 1280×1024, 1400×1050, 1600×900, 1600×1200, 1856×1392, 1920×1080.		
S	ystem resolution		1920×1200(16,770,000 colors), 1920×1400(16,770,000 colors)		
			OUTPUT: Line OUT x 1 (Stereo output level 80 200mW Signal to Noise ratio 90dB)		
Α	udio		INPUT: MIC x 1 (Monaural), Plug type : 93.5 pin JACK		
			CF CARD TYPE I/II x 1 (Primary IDE Master)		
С	F Card slot		- CF installed (2GB, 1 partition)		
	econdary IDE		Dedicated 40-pin, half-pitch connector (for a CD-ROM/DVD-ROM drive) (Side in the bottom)		
	econdary IDE erial		Destinated 40-9hr, inampitati commetted (tid a 20-10-0hr) miner (site at interbution)  RS-232C (general-purpose); 2ch (SERIAL PORT1.2) 9-pin D-SUB connector, Baud rate: 50 - 115,200bps		
	enai	I/F	RS-222c (getrelappunose): 2cm (serialar Port 1,2 Psint 0-sols connector), Bauditate: 30 - 113,2000ps Ethernet 100BASE-TX/10BASE-T RJ-45 connector		
L	AN1	Controller	Editerier (1009ASE-17/109A		
		I/F	Built in Intel ICH4 Ethernet 100BASE-T RJ-45 connector		
L	AN2	Controller			
			Intel 82541 PI 4ch (USB 2.0 specification [High/Full/Low Speed])		
	USB Keyboard/Mouse		4cn (USB 2.1 Specinication [Ingini*rulinLow Speed]) Kevboard/Mouse via USB *1		
	F&elT		8 F&eIT device modules can be connected (max) *2*3 (Power consumption of external units should be less than 3.0A)		
	/atchdog timer		1sec to 255sec, 255 level; RESET when time-up occurs  CPU and board temperature, power supply voltage, and fan speed		
	ardware Monitorin	ng	CPU and board temperature, power supply voitage, and tan speed  Lithium backup battery life: 10 years or more (at 25°C at ON/OFF); Real time clock precision error: < ±3 minutes per month		
	ED display lanual switch inpu		Power, CompactFlash activity, 2 x User programmable LED  1 x Reset switch, 1 x User programmable switch		
IV		Input Voltage			
_		Power Consumption (max)	12 - 24VDC ±5%		
Р		Power Consumption (max) External power supply capacity	12V input: 2.4A / 24V input: 1.3A  Secondary IDE connector +5V: 500mA · CF card slot +3.3V: 500mA · USB I/F +5V: 2A(500mA×4)		
		External power supply capacity			
	imensions (mm)		74.7(w) × 120.0(d) × 94.0(h) [2.95" x 4.7" x 3.7"] (excluding protrusions)		
V	/eight		800g [1.75lbs] (900g [2lbs] when equipped with DIN-rail metal fittings)		
Cor	dition		Specification		
	Operating Temperature		0~50°C *5		
si s	Storage Temperature		-10~60°C		
96	Humidity		10~90%RH (no condensation)		
S	Floating Dust Particles		Normal		
la l	Corrosive Gases		None		
e l	Nining and the	Line-noise	AC line/2kV, Signal line/1kV (IEC1000-4-4Level 3, EN61000-4-4Level 3)		
딭	Noise resistance	Atmospheric discharge	Contact discharge / 4kV (IEC1000-4-2Level2, EN61000-4-2Level2), Atmospheric Discharge / 8kV (IEC1000-4-2Level3, EN61000-4-2Level3)		
inviro	Vibration Resistance	Sweep Resistance	10 - 57Hz/semi-amplitude 0.15mm, 57 - 150Hz/2.0G, 40min each in x, y, and z directions (JIS C0040 compliant, IEC68-2-6 compliant)		
	Impact Resistance	e	15G, half-sine shock for 11ms in x, y, and z directions (JIS C0041 compliant, IEC68-2-27 compliant)		
	Grounding		Class D grounding (previous class 3 grounding)		

### I/O Controllers

#### Integrated CPU and firmware. Remote I/O easily controlled from your PC



These ethernet-based remote I/O system is configured by interconnecting I/O device modules onto an ultra-compact Controller Module. This system can be used in a wide-range of applications and controlled using a PC or in coordination with an F&eIT Server.

#### I/O Controller Unit CPU-CA Series

CPU-CA20(FIT)GY (

CPU-CA10(FIT)GY (

#### CPU-CA20(FIT)GY High-speed / advanced-functions

- 3 times faster than model CPU-CA10(FIT)GY
  The CPU-CA20(FIT)GY uses an SH4 240 MHz CPU and supports 100
  Mbps (100 BASE-TX) ethernet, ensuring faster I/O and communication
  processing. Achieves higher speed communication with a response time
  that is roughly 1/3 (1.5 msec to 0.5 msec)\* that of the previous model.
- Increased number of units can interconnect in same network In the standalone startup mode (w/out I/O Assist Server Unit), up to 128 units can be installed on the same network.



Installation on DIN rail

[Device Modules] P.08

Power supply optional [Power Supplies] [P. 1]

#### ■ Software (CD-ROM)

Windows device module access library API-CAP(W32)[CD-ROM] [CPU-CA20(FIT)GY, CPU-CA10(FIT)GY, SVR-IOA(FIT)GY, SVR-IOA2(FIT)GY included]

The API-SBP(W32) drivers provide commands for stacked Device Modules in Windows-standard Win32API(DLL) format. Programs can be developed in various programming languages that support Win32API (e.g. Visual Basic and Visual C++).

·Digital & analog I/O, counters, and GPIB communication device modules are supported.

Latest driver versions can be downloaded free from CONTEC's Web site.

\* Linux driver library API-CAP(LNX) can be downloaded free from CONTEC's Web site

- · Windows Device Module Access Library API-CAP(W32)[CD-ROM]
- DDE, SuiteLink Server FIT-SVR(W32)

Supported OS: Windows® XP/2000/NT4.0 (SP5 or later)/Me/98

· Utility software

Setting up nodes, updating firmware and monitoring diagnosis Supported OS: Windows® XP/2000/NT4.0 (SP3 or later)/Me/98

[Software] **P. 13~15** 

ltem		Specifications		
		CPU-CA20(FIT)GY	CPU-CA10(FIT)GY	
CPU		SH4 240MHz	SH3 60MHz	
Memory		Flash ROM: 4MB(32Mbit)	Flash ROM:512KB(4Mbit)	
		SDRAM: 32MB)256Mbit)	EDO DRAM:2MB(16Mbit)	
Interface (to host)		100BASE-TX / 10BASE-T	10BASE-T(IEEE802.3)	
Simultaneous usable	Stand-alone mode	128 (max)	8 (max)	
devices *1	SVR-IOAx(FIT)GY	8 (max)	8 (max)	
Connectable Device	Modules	8 devices (max)		
Response speed *4	1 device module	approx 600µsec	approx 1.5msec	
	8 device modules	approx 1msec	approx 2.5msec	
Power Voltage		5VDC 5% - 2-piece power input connector (removable) on the front		
		Use of F&eIT Series dedicated power supply or third-party stabilizing power supply is recommended		
Power Consumption		0.7A (max)	0.5A (max)	
Grounding Terminal		Grounding terminal is included (located) in power plug		
Operating Temperature/Humidity		0 to 50°C, 10 to 90% RH ((no condensation)		
Dimensions (mm)		25.2(W) × 64.7(D) × 94.0(H) (1"×2.54"×3.7")		
Weight		100g (3.52oz)		

- \*1: The number of the devices that can be used simultaneously in the same network.
- \*2: The total maximum power consumption by each module can not exceed the rated output current of the power supply unit.
- \*3: The stack connector supplies the power to each device module. Supplied power can not exceed the permissable current of a stack connector (max 3.0A)
- \*4: It is the speed when using digital I/O modules. The speed of other modules is different.

#### Fan-less, Compact Design

Utilizing a low-heat generating CPU, these fanless I/O Controllers run on minimal power. Their compact design (94 mm imes 64.7 mm) requires little installation space.

#### DDE Communication with Excel and **SCADA (HMI) Software**

DDE and SuiteLink server FIT-SVR(W32) (included with controllers) enable communication to be controlled by software that supports DDE client functions such as Microsoft® Excel or Wonderware InTouch®.

#### **Computer-based Remote Control**

The Windows® drivers that are provided enable remote control of the I/O on a networked machine running in a Windows® environment. The I/O can be controlled in a non-Windows environment through the use of the socket functions.

### **Application**

#### Remote monitor and control - No program required

When using the Monitor & Control Server [SVR-MMF2(FIT)] no program in needed to implement remote monitoring and control systems.

[Monitoring & Control Server] P.17

I/O Controlle

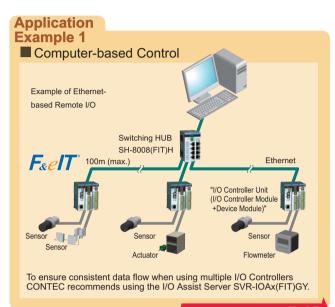


#### **Application Example 3**

#### ■ Remote I/O Control via ACTIVE TOUCH®



You can use CONTEC's ACTIVE TOUCH®, HMI Programmable Display, as a control terminal for Ethernetbased remote I/O systems Additional user interface functions can be easily added even after the system has been installed



[I/O Controller Modules] **P. 15** 

#### **USB-based Controllers also available**

#### **USB-based I/O Controller Module** CPU-CA10(USB)GY (

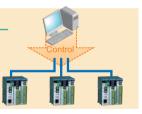
With this module, you can establish USB direct connected distribution I/O system. The same expansion modules can be used with this and F&eIT I/O controller.



#### Software (CD-ROM)

#### Windows Driver Library API-USBP(WDM)

Windows-standard Win32 API(DLL) format software drivers are included. These are compatible with CONTEC PCI bus I/O boards and PC cards at the API level.



## **Switching HUB**

#### **Network Expansion**

### Embedded 10M/100M Auto-Switching Hub





Installation on DIN rail

This ultra-compact and lightweight general-purpose switching hub is ideal for embedded use

Although designed for use with F&eIT systems it can also be used in ordinally networks.

- Equipped with eight 10M/100 M auto-switching ports (one can serve as an uplink port)
- Equipped with 35 mm DIN rail mounting mechanism
- FG terminal is included in power input connector

#### SH-8008(FIT)H (€

Power supply optional [Power Supplies] **P.11** 

	<u> </u>
ltem	Specification
Ethernet	IEEE802.3/IEEE802.3u
Communication method	All ports are Full/Half Duplex (auto switching)
Flow control	Full Duplex: IEEE802.3x-compliant Flow Control; Half Duplex: Back Pressure
Available ports	8
Switching mode	Store & Forward
Address table	1,024 entry
Rated volatage input	5V-24VDC ±5% (Use of F&eIT Series dedicated power supply or third-party stabilizing power supply is recommended)
Power Consumption (max.)	5V input: 0.54A, 12V input: 0.22A, 24V input: 0.15A
Operating Temperature/ Humidity	0 to 50°C, 10 to 90% RH (no condensation)
Dimensions (mm)	$52.4(W) \times 64.7(D) \times 94.0(H)$ (Exclusive of protrusions)
Weight	160g



### **Device Modules**

# Easy stacking connection. Extensive line-up designed to meet your specific device requirements

These modules provide additional I/O communication for Micro Controllers, I/O Controllers and Monitoring & Control Servers.

				cro Controllers, I/O Controllers and	worldoning & Control Servers.	
	solat	ted Dig	gital I/O Modules			
Model		Model	Some less connector	Scenless confeder	Screwless connector	Isolated C E Screen
			12 to 24 VDC 16 Inputs 12 to 48 VDC 16 Outputs	12 to 24 VDC 8 Inputs 12 to 48 VDC 8 Outputs	36 to 48 VDC 8 Inputs/Outputs	12 to 24 VDC 4 Inputs 12 to 48 VDC 4 Outputs
Sp	ecification	ıs	DIO-16/16(F T)GY	DIO-8/8(FIT)GY	DIO-8/8H(FIT)GY	DIO-4/4(FIT)GY
	Number of ir	put signals	16 (16 points share one common)	8 (8 points share one common)		4 (4 points share one common)
	Input Type		Photocoupler isolated input (supports both current sink and current source)			
	Input Resistance		3kΩ	3kΩ	12kΩ	3kΩ
	Input ON Current		3.4 mA or more	3.4 mA or more	3.4mA or more	3.4 mA or more
Input	Input OFF C	urrent	0.16 mA or less	0.16 mA or less	0.16 mA or less	0.16 mA or less
=	Response T	me	1 msec (max)	1 msec (max)	1 msec (max)	1 msec (max)
	External Circuit Power Supply		12 to 24 VDC ( 15%) (4 mA/12 V to 8 mA/24 V per point)	12 to 24 VDC ( 15%) (4 mA/12 V to 8 mA/24 V per point)	36 to 48 VDC ( 15%) (3mA/36V to 4mA/48V per point)	12 to 24 VDC ( 15%) (4 mA/12 V to 8 mA/24 V per point)
	Interrupt Re	quest	All inputs can generate interrupts (One level out of IRQ 5/7/9)			
	Number of C	output Points	16 (16 points share one common)	8 (8 points share one common)		4 (4 points share one common)
	Output Form		Photocoupler isolated open collector output	ut (current sink type)		
		Output Voltage		12 to 24 VDC ( 15%)	36 to 48 VDC ( 15%)	12 to 48 VDC ( 15%)
Ħ		Output Current	12 to 24V - 150mA per point (max)	150mA per point (max)	50mA per point (max)	12 to 24 V - 150mA per point (max)
Output			36 to 48V - 50mA per point (max)			36 to 48 V - 50mA per point (max)
	Response T	me	1 msec (max)			
	External Circuit Power Supply		12 to 48 VDC ( 15%)	12 to 24 VDC ( 15%)	36 to 48 VDC ( 15%)	12 to 48 VDC ( 15%)
Int	Internal Current Consumption		5 VDC (5%) 150 mA (max) *1			
Cabling Distance (max)		ce (max)	Approx. 50 m (depending on wiring environment)			
Di	Dimensions (mm)		25.2 (W) x 64.7 (D) x 94.0 (H) (excluding p	protrusions)		
	Weight (main unit)		100 g			
Ap	Applicable Wire Dia.		AWG 24 to 16	AWG 28 to 20		AWG 28 to 16
Applicable plug (provided)		(provided)	FMC 1, 5/18-ST-3, 5 (made by PHOENIX CONTACT)	FK-MC 0, 5/9-ST-2, 5 FRONT-MC 1, 5/12-ST-3, 8 (made by PHOENIX CONTACT) (made by PHOENIX CONT		FRONT-MC 1, 5/12-ST-3, 81 (made by PHOENIX CONTACT)

Isolated Di	Isolated Digital Input Modules			
Model	Isolated C €	Isolated CE	tsolated CE Suppless	Isolated C E
	12 to 24 VDC 32 Inputs	12 to 24 VDC 16 Inputs	36 to 48 VDC 16 Inputs	12 to 24 VDC 8 Inputs
Specifications	DI-32(FIT)GY	DI-16(FIT)GY	DI-16H(FIT)GY	DI-8(FIT)GY
Number of input signals	32 (16 points share one common)	16 (8 points share one common)		8 (8 points / common)
Input Type	Photocoupler isolated input (supports both			
Input Resistance	3kΩ	3kΩ	12kΩ 3kΩ	3kΩ
Input ON Current	3.4 mA or more	3.4 mA or more	3.4 mA or more 3.4 mA or more	3.4mA or more
Input OFF Current	0.16 mA or less	0.16 mA or less	0.16 mA or less 0.16 mA or less	0.16mA or less
Response Time	1 msec (max)	1 msec (max)	1 msec (max) 1 msec (max)	1 msec (max)
External Circuit Power Supply	12 to 24 VDC ( 15%)	12 to 24 VDC ( 15%)	36 to 48 VDC ( 15%)	12 to 24 VDC (15%)
	(4 mA/12 V to 8 mA/24 V per point)	(4 mA/12 V to 8 mA/24 V per point)	(3mA/36V to 4mA/48V per point)	(4mA/12 V to 8mA/24 V per point)
Interrupt Request	All inputs can generate interrupts (One lev	el out of IRQ 5/7/9)		
Internal Current Consumption	5 VDC ( 5%) 150 mA (max) *1	5 VDC ( 5%) 150 mA (max) *1		
Cabling Distance (max)	Approx. 50 m (depending on wiring environment)			
Dimensions (mm)	25.2 (W) x 64.7 (D) x 94.0 (H) (excluding protrusions)			
Weight (main unit)	100 g			
Applicable Wire Dia	AWG 24 to 16	AWG 28 to 20		AWG 28 to 16
Applicable plug (provided)	FMC 1, 5/18-ST-3, 5 (made by PHOENIX CONTACT)	FK-MC 0, 5/9-ST-2, 5 (made by PHOENIX CONTACT)		FRONT-MC 1, 5/12-ST-3, 81 (made by PHOENIX CONTACT)

#### Non-isolated Digital I/O Module TTL (5 VDC) 8 Inputs/Outputs Specifications DIO-8D(FIT)GY Number of input signals 8 (8 points share one common) Input/Output Form Non-isolated TTL level I/O (negative logic) Input pull-up resistance 100 k $\Omega$ (1 common) Response Time 200 nsec (max) Rating -0.5 to +5.5 VDC Output Current IoL=6mA,IoH=2mA (per point) Internal Current Consumption 5 VDC (5%) 150 mA (max) \*1 Approx. 1.5 m (depending on wiring Cabling Distance (max) environment) 25.2 (W) x 64.7 (D) x 94.0 (H) Dimensions (mm) (excluding protrusions) Weight (main unit) 100 g Applicable Wire Dia. AWG 28 to 16 Applicable plug (provided) FRONT-MC 1, 5/12-ST-3, 81 (made by PHOENIX CONTACT)

I	Isolated Digital Output Modules					
		Model	Isolated CE Strew-Ess Cornector  12 to 48 VDC 32 Outputs	Screeness Connector Connec	Scew construction 12 to 48 VDC 8 Outputs	
Sp	ecificatio	ns	DO-32(FIT)GY	DO-16(FIT)GY	DO-8(FIT)GY	
	Number of	Output Points	32 (16 points share one common) 16 (8 points share one common) 8 (8 points share one common)			
	Output For	m	Photocoupler isolated open colle	ector output (current sink type)		
Output	Rating	Output Voltage	12 to 48 VDC ( 15%)			
O		Output Current	12 to 24V - 150mA per point (ma	ax)		
			36 to 48V - 50mA per point (max	x)		
	Response		1 msec (max)			
_	External Circuit Power Supply		12 to 48 VDC ( 15%)			
_	Internal Current Consumption		5 VDC ( 5%) 150 mA (max) *1			
_	Cabling Distance (max)		Approx. 50 m (depending on wiring environment)			
	Dimensions (mm)		25.2 (W) x 64.7 (D) x 94.0 (H) (e	excluding protrusions)		
	Weight (main unit)		100 g	I	I	
_	plicable Wi		AWG 28 to 16	AWG 28 to 20	AWG 28 to 16	
Ap	Applicable plug (provided)		FMC 1, 5/18-ST-3, 5 (made by PHOENIX CONTACT)	FK-MC 0, 5/9-ST-2, 5 (made by PHOENIX CONTACT)	FRONT-MC 1, 5/12-ST-3, 81 (made by PHOENIX CONTACT)	

Isolated Analog Input Modules			
Model	Isolated CE Streniess Connector	Isolated  C E  Stray connector	
	Isolated analog input, 12 bits, 8 channels	Isolated analog input, 16 bits, 4 channels	
Specifications	ADI12-8(FIT)GY	ADI16-4(FIT)GY	
Number of Channels	8 differential inputs	4 differential inputs	
Input Type	Bus isolated voltage input	Bus isolated voltage/current input	
Input Range	Bipolar ±10V, ±5V	[Voltage] Bipolar ±10V	
	Unipolar 0 to 10 V, 0 to 5 V	[Current] 0 to 20 mA	
Max. Input Rating	± 20 V	[Voltage] ±20 V	
		[Current] 30 mA	
Resolution 12 bits		16 bits	
Non-linearity error*2	±3 LSB	[Voltage]±8 LSB ( ±0.012% of FSR)	
		[Current] ±20 LSB ( ±0.030% of FSR)	
Conversion Speed	Number of channels x 10 μ sec + 20 μ sec	[Voltage] Number of channels x 10 µsec +20 µsec	
		[Current] Number of channels x 40 µsec +20 µsec	
Data Buffer	8 words	64 words	
Sampling Timer *3	10 µsec to 1,073,741,824 µsec		
Interrupt Request *3	Select two or more from sampling clock input and 4 other events (One level out of IRQ 5/7/9)	Select two or more from sampling clock input and 5 other events (One level out of IRQ 5/7/9)	
Internal Current Consumption	5 VDC (±5%) 350 mA (max) *1	5 VDC ( ±5%) 350 mA (max) *1	
Cabling Distance (max)	1.5m		
Dimensions (mm)	25.2 (W) x 64.7 (D) x 94.0 (H) (excluding protrusions)		
Weight (main unit)	100 g		
Applicable Wire Dia.	AWG 28 to 20	AWG 28 to 16	
Applicable plug (provided)	FK-MC 0, 5/12-ST-2, 5	FRONT-MC 1, 5/12-ST-3, 81	
	(made by PHOENIX CONTACT)	(made by PHOENIX CONTACT)	

#### \*2 An error of about 0.1% of the maximum range sometimes occurs as a non-linearity error at an ambient temperature of 0°C and 50°C.This error can be reduced by calibrating at the operating environment temperature. \*3 Can be used only when connected to the CPU-SBxx(FIT)GY.

#### ADI12-8(FIT)GY dedicated low-pass filter Model

	ADI12-8(FIT)GY dedicated low-pass filter
Specifications	ATLF-8(FIT)GY
Input Range	-10 V to +10 V
Max. Input Voltage	±20V
Input Impedance	1ΜΩ
Input Channel	8 differential input channels
Accuracy	±0.2%
Filter Shutoff Frequency	10 Hz (typ.)
Dimensions (mm)	50.4 (W) x 64.7 (D) x 94.0 (H)
	(excluding protrusions)
Weight (main unit)	105 g
Applicable Wire Dia.	AWG 28 to 20
Applicable plug	FK-MC 0, 5/12-ST-2, 5
	(made by PHOENIX CONTACT)
	•

#### \*1 Stack Connection

■ 8 Modules / 3A (max) A maximum of 8 device modules can be connected to each controller.
Total current consumption of all connected modules must not exceed 3A.



### **Device Modules**

#### **Isolated Analog Output Modules** CE Isolated Analog Output 16bit 4ch Isolated Analog Output 12bit 4ch DAI12-4(FIT)GY DAI16-4(FIT)GY Specifications Number of Channels 4 channels Output Type Bus isolated voltage/current output [Voltage] Bipolar ±10 V, ±5 V Unipolar 0 to 10 V, 0 to 5 V Output Range [Voltage] Bipolar ±10 V (output current ±5 mA) [Current] 0 to 20 mA (output current ±5 mA) [Current] 0 to 20 mA Output Impedance Voltage output range: 10 Ω (max) Voltage output range: 10 Ω (max) [Voltage] ±18 LSB (±0.027% of FSR) [Current] ±18 LSB (±0.027% of FSR) [Voltage] ±3 LSB [Current] ±5 LSB Conversion Accuracy\*1 [Voltage] 10 µ sec/ch [Voltage] 10 μ sec/ch [Current] 20 μ sec/ch Settling Time [Current] 20 µ sec/ch Data Buffer 64 words Internal Sampling Timer \*2 10 μ sec to 1,073,741,824 μ sec Interrupt Request\*2 Select two or more from timer clock input and 3 other events (one of IRQ5/7/9 set to 1 level) 3 other events (one of IRQ5/7/9 set to 1 level) Internal Current Consumption 5 VDC (±5%) 400 mA (max.) 5 VDC (±5%) 500 mA (max.) Cabling Distance (max) 25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions) Dimensions (mm) Weight (main unit) 100g Applicable Wire Dia AWG 28 to 20 AWG 28 to 16 Applicable plug (provided) FK-MC 0 5/12-ST-2 5 FRONT-MC 1 5/12-ST-3 81 (made by PHOENIX CONTACT) (made by PHOENIX CONTACT)

## Pt100 Temperature Sensor Input Module

i troo remperati	ire delisor ilipat module
Model	Isolated  C E  Strew less Connector
	Pt100 Temperature Sensor Input Module
Specifications	PTI-4(FIT)GY
Number of Channels	4 channels
Compatible Platinum RTD	Pt100 (JIS C1604-1997, IEC 751 1983),
	JPt100 (JIS C1604-1989)
Wiring Method	3-lead type, 4-lead type
Temperature Measurement Range	Pt100: -200 to 850°C JPt100: -200 to 510°
Ambient Temperature 0 to 50°C  Ambient Temperature  Ambient Temperature  15 to 35°C	±0.3°C*1
Ambient Temperature	±0.15°C*1
Resolution	0.01°C
Conversion Speed	Selectable from 150 ms/40 ms/5 ms per channel
Output Current for Temperature Detection	1mA
Isolation Method	Across platinum RTD and power supply: Photocoupler isolation
	Across platinum RTD input channel: No isolation
Times of update Flash ROM (RTD Data)	100,000 times (max)
Internal Current Consumption	5 VDC (±5%) 500 mA (max)
Dimensions (mm)	25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions)
Weight (main unit)	100g
Applicable Wire Dia.	AWG 28 to 20
Applicable plug (provided)	FK-MC 0,5/9-ST-2,5 (made by PHOENIX CONTACT)

<sup>\*1</sup> When conversion speed is set to 150 ms

#### **Isolated Counter Modules** 16bit UP 12 to 24 VDC,8channels 24bit UP/DOWN 16bit UP 5 to 12 VDC, 2 channels 5 VDC, 8 channels Specifications CNT24-2(FIT)GY CNT16-8(FIT)GY CNT16-8I (FIT)GY Number of Channels 2 channels 8 channels Counting Method 24-bit up/down count 1-phase 16-bit up count 1-phase w/gate control, 2-phase Photocoupler isolated input (for current sink output) Input Type Photocoupler isolated input (Supports both current sink and current source) Input Resistance 220 Ω or more 3 kO 5 to 12 VDC (±10%) 400 mA (min ) 12 to 24 VDC (±15%)(4 mA/ 12V to 8 mA/24 V per point) External Circuit Power Supply 5 VDC (±10%) (4 mA per point) Response Frequency 10 kHz (max) Duty 50% (max) 500 kHz (max) 5 kHz (max) Duty 50% (max) Duty 50% (max) Digital Filter \*1 0.1 µsec to 1056.1 µsec 0.25 µsec to 131.072 msec Programmable Timer \* 1 msec to 200 sec Two more selectable from timer time-up and setting counter value match(one of IRQ5 / 7 / 9 set to 1 level) Interrupt Request Counter Carryover (one of IRQ5 / 7 / 9 set to 1 level) 1 point × 2 channels Output\*2 Number of Outputs Photocoupler isolated open collector output (current sink Output Form type) (negative logic) n/a Output Rating 35 VDC 50 mA (max) Pulse Width External Power Supply 0 to 104.45 msec 5 to 12 VDC (±10%) Internal Current Consumption 5 VDC (±5%) 150 mA (max) Cabling Distance (max) Approx. 30m 50 m (depending on wiring environment) Dimensions (mm) 25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions) Weight (main unit) 100g Applicable Wire Dia AWG 28 to 20 AWG 28 to 16 FRONT-MC 1.5/12-ST-3.81 Applicable plug (provided) FK-MC 0.5/9-ST-2.5 (made by PHOENIX CONTACT) (made by PHOENIX CONTACT)

#### **Reed Relay Output Module** Reed Relay Output 4 points RRY-4(FIT)GY Specifications Number of Outputs Output Form Reed relay contact (1 make output) Contact Specifications Max. Allowable Voltage 125 VAC, 30 VDC (max) Max. Switching Current 2A (max) Contact Resistance 30 mm $\Omega$ or less Response Time Within 7 msec 20 million operations or more (switching frequency:180 operations /minute) Mechanical Life Electrical Life 10 million operations or more Relay (switching frequency: 20 operations /minute) PA1a-5V Internal Current Consumption 5 VDC (±5%) 150 mA (max.)\*1 Cabling Distance (max) Approx. 50 m (depending on wiring environment) Dimensions (mm) 25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions) Weight (main unit) 100g Applicable Wire Dia AWG 28 to 16 FRONT-MC 1,5/12-ST-3,81 (made by PHOENIX CONTACT) Applicable plug (provided)

### **Stack Connection**

#### ■ 8 Modules / 3A (max)

A maximum of 8 device modules can be connected to each controller. Total current consumption of all connected modules must not exceed 3A.

<sup>\*1:</sup> An error of about 0.1% of the maximum range can occur in the conversion accuracy at an ambient temperature of 0°C and 50°C

<sup>\*2:</sup> Can be used only when connected to the CPU-SBxx(FIT)GY.

<sup>\*1:</sup> Can be used only when connected to the CPU-SBxx(FIT)GY.

<sup>\*2:</sup> Not supported when connected to the CPU-CA10(USB)GY.

#### **Serial Communication Modules** Specifications Number of Channels 2 channels 1 channel I/O Specifications RS-232C RS-422A/RS-485 Asynchronous serial transmission (full-duplex) Transmission Method Baud Rate 2 to 921,600 bps\*1 Data Length 5, 6, 7, or 8 bits, 1, 1.5 or 2 stop bits Parity Check Even, odd, no parity 162850 or equivalent (FIFO buffer send: 128 byte, receive: 128 byte) UART Internal Current Consumption 5VDC (±5%) 100mA (max) 5VDC (±5%) 300mA (max) Connector 9-pin D-sub (male) × 2 9-pin D-sub (female) × 1 Dimensions (mm) 25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions) Weight (main unit) 100g \*1: 15~921,600bps when using API-SBP(W32) driver (included)

<b>GPIB Comm</b>	unication Module	
Model	Isolated CE	
	GPIB 1-channel	
Specifications	GP-IB(FIT)GY	
Number of Channels	1 channel	_
I/O Specifications	GPIB (IEEE-488.1, IEEE-488.2) standard-compliant	_
Transmission Method	8bit parallel / 3-line handshake	Device Mod
Transmission Speed	30 KB/sec (max)	Seri
Internal Current Consumption	5VDC (±5%) 230mA (max)	
Dimensions (mm)	25.2 (W) × 64.7 (D) × 94.0 (H) (excluding protrusions)	Power Sup Seri
Weight (main unit)	100g	
		Opti

Table of Device Module Series & Power Supply Series

# Power Supplies

#### **AC-DC Power Supply Unit**

POW-AD13GY

POW-AD22GY (€

\* POW-AD13GY



#### **DC-DC Power Supply Unit**

POW-DD10GY (E

POW-DD43GY

\* POW-DD10GY

Item	Specification			
item	POW-AD13GY	POW-AD22GY	POW-DD10GY	POW-DD43GY
Input	85~132VAC	85~264VAC	10~30VDC	30~50VDC
	5.0VDC±5%			
Output	3.0A (max)	2.0A (max)	3.0A (max)	
Operating Temperature / Humidity	umidity 0 to 50°C, 10 to 90% RH (no condensation)		0 to 40°C, 10 to 90% RH (no condensation)	
Dimensions (mm)	52.4(W) × 64.7(D) × 94.0(H) (Exclusive	of protrusions)	25.2(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)	
Weight (main unit)	Weight (main unit) 150g 110g		150g	

#### **AC Adapter Power Supplies**

P0A201-10 12VDC 1A output(for RP-COM(FIT)H)

P0A200-20 5VDC 2A output(for RP-COM(FIT)H-AF)

#### PoE Power Supplies for RP-COM(FIT)H-AF

POW-CB30 (af) Power-over-Ethernet Power Supply Unit (100-240VAC)

POW-CBM4 (af) 4-port PoE Power Supply Switching HUB (100-115VAC)

### **Accessories**

### Compact Flash

FixDisk Compact Flash - Can be partitioned (like a HDD) before Installing OS.

FixDisk 1GB CF-1GB
FixDisk 512MB CF-512MB

#### **F&elT Series Fans**

No fan is needed when F&elT Modules are used in temperatures of 0 to  $50^{\circ}\text{C}$ .

Up to 10°C above specified operating temperature is allowed when using optional fan [FAN-FIT].

Item	Specification
Rated Voltage	DC5V±10%
Rated Current	0.18A
Max. Airflow	0.1m³/min
Max. Static Pressure	2.3mmH <sub>2</sub> O
Noise	30dB
Operating Temperature	5 to 60°C
Rotating Speed	5200rpm
Life	50,000 h (temperature: 20°C, humidity: 65%), 30,000 h (temperature: 60°C)
Dimensions (mm)	42.6(W) × 47.2(D) × 11.2(H) (Exclusive of protrusions)
Weight (main unit)	40g

## **Device Modules Compatibility Table**

1 2 3 4	5 6 7 8	9	Micro Controllers	I/O Controll	ers	Monitoring & Control Servers	I/O Assist Servers
Max 8 n (Total power consur A maximum of eight modules can be However, the power consumption of modules cannot exceed a total of 3	mption 3 A or less) be stacked on one unit. of the configuration of co	nnected device	CPU-SB303-FIT-36 CPU-SB303-FIT	CPU-CA20(FIT)GY CPU-CA10(FIT)GY	CPU-CA10(USB)GY	SVR-MMF2(FIT)	SVR-10A2(FIT)GY SVR-10A(FIT)GY
Function	Model F	Power Consumption	55	55	5	S	22.22
Opto-isolated Digital I/O							
12 to 24 VDC 16 Inputs/12 to 48 VDC 16 Output:	s DIO-16/16(FIT)GY	0.15A	0	0	0	-	
12 to 24 VDC 8 Inputs/Outputs	DIO-8/8(FIT)GY	0.15A	0	0	0	0	
36 to 48 VDC 8 Inputs/Outputs	DIO-8/8H(FIT)GY	0.15A	0	0	_	0	
12 to 24 VDC 4 Inputs/12 to 48 VDC 4 Outputs	s DIO-4/4(FIT)GY	0.15A	0	0	_	0	
Non-isolated Digital I/O							
TTL (5 VDC) 8 Inputs/Outputs	DIO-8D(FIT)GY	0.15A	0	0	_	0	
Opto-isolated Digital Input							
12 to 24 VDC 32 Inputs	DI-32(FIT)GY	0.15A	0	0	0	-	
12 to 24 VDC 16 Inputs	DI-16(FIT)GY	0.15A	0	0	0	0	
36 to 48 VDC 16 Inputs	DI-16H(FIT)GY	0.15A	0	0	_	0	
12 to 24 VDC 8 Inputs	DI-8(FIT)GY	0.15A	0	0		0	_
Opto-Isolated Digital Output							Dev
12 to 48 VDC 32 Outputs	DO-32(FIT)GY	0.15A	0	0	0	-	Device modules cannot be stacked
12 to 48 VDC 16 Outputs	DO-16(FIT)GY	0.15A	0	0	0	0	В
12 to 48 VDC 8 Outputs	DO-8(FIT)GY	0.15A	0	0	_	0	<u>u</u>
Isolated Analog Input							es
Isolated analog input, 12 bits, 8 channels	ADI12-8(FIT)GY *4	0.35A	0	0	0	0	car
Isolated analog input, 16 bits, 4 channels	ADI16-4(FIT)GY	0.30A	0	0	0	0	ino
Isolated Analog Output							be
Isolated analog output, 12 bits, 4 channels	DAI12-4(FIT)GY	0.40A	0	0	0	0	StS
Isolated analog output, 16 bits, 4 channels	DAI16-4(FIT)GY	0.50A	0	0	0	0	čķ
Pt100 Temperature Sensor Input							ď.
Pt1000 temperature input, 4 channels	PTI-4(FIT)GY	0.50A	0	0	0	-	
Isolated Counter							
24-bit up/down, 5 to 12 VDC, 2 channels	CNT24-2(FIT)GY	0.15A	0	0	0	0	
16-bit up, 12 to 24 VDC, 8 channels	CNT16-8(FIT)GY	0.15A	0	0	-	0	
16-bit up, 5 VDC, 8 channels	CNT16-8L(FIT)GY	0.15A	0	0	T -	0	
Reed Relay Contact Output							
125 VAC/30 VDC 2 A, 4 lead relay contact output	ts RRY-4(FIT)GY	0.15A	0	0	_	-	
Serial Communication							
RS-232C 2-channel	COM-2(FIT)GY	0.10A	O#1	-		O#2	
RS-422/485 1-channel	COM-1PD(FIT)GY	0.30A	○#5	=	_	O#2	
GPIB Communication							
GPIB (IEEE-488) 1-channel	GP-IB(FIT)GY	0.23A	O#3	-		-	

<sup>\*1:</sup> One module can be connected in the Compatible mode, and up to three modules can be connected in the Enhanced mode.

\*2: Up to four modules can be connected.

\*3: Up to three modules can be connected.

\*4: The low path filter for analog input module [ATLF-8(FIT)GY] can be provided as an option.

## **Power Supplies**

AC-DC			DC-DC		
Model	Output	Input Voltage	Model	Output	Input Voltage
POW-AD13GY	5VDC 3.0A	85~132VAC	POW-DD10GY	5VDC 3.0A	10~30VDC
POW-AD22GY	5VDC 2.0A	85~264VAC	POW-DD43GY	5VDC 3.0A	30~50VDC
AC Adapters			PoE Power Supplies	for RP-COM(FIT)H-AF	
Model	Output	Input Voltage	Model	Output	Input Voltage
POA201-10	12VDC 1.0A	90~264VAC	POW-CB30(af)	48VDC 0.5A	100~240VAC
POA200-20	5VDC 2.0A	90~264VAC	POW-CBM4(af)	48VDC 1.8A	100~115VAC

<sup>\*</sup> Please use commercially available power supplies when you use CPU-SB303-FIT. CONTEC recommends 50W(min) power supply when you use it by stand-alone.

<sup>\*5:</sup> Up to 2 modules can be used in Compatible Mode or 3 modules in Enhanced Mode on one unit.



### Software

### Windows® driver library for CPU-SBxx(FIT)GY

API-SBP(W32)

The API-SBP(W32) driver software provides commands in Windows-standard Win32API(DLL) format to Device Modules stacked on the CPU-SB10(FIT)GY, CPU-SB20(FIT)GY and CPU-SB303-FIT.

A diagnostics monitor allows you to confirm operation without the aid of a program.

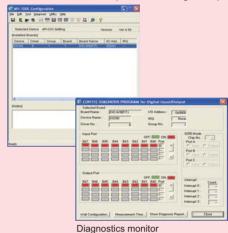
Programs can be developed in a variety of programming languages that support Win32API (e.g. Visual Basic and Visual C++).

- Digital I/O, analog I/O, counters and GPIB communication device modules are supported
- · Compatible with API-PAC(W32) driver library for CONTEC interface boards / cards
- Windows® XP/XP Embedded/2000/NT4.0/Me/98/98 Second Edition/95 OSR2/95 supported
- Includes Visual Basic and Visual C++ sample programs

Setup program (API-TOOL configuration)







Online help

Sample program

Latest versions can be downloaded free from CONTEC's web site.

\* To develop applications in Linux, use the Linux general-purpose I/O driver IO-LIB(LNX) [also available for free download from CONTEC's web site]. Not required when using Serial Communication Modules COM-2(FIT)GY or COM-1PD(FIT)GY. They are recognized as standard COM parts when using Linux.

### Windows® driver library for CPU-CAxx(FIT)GY

API-CAP(W32)

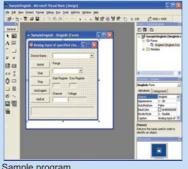
The API-SBP(W32) driver software provides commands in Windows-standard Win32API(DLL) format to Device Modules stacked and networked with the CPU-CA10(FIT)GY and CPU-CA20(FIT)GY.

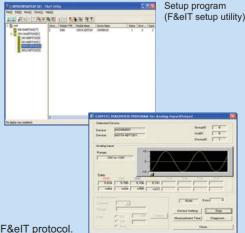
A diagnostics monitor allows you to confirm operation without the aid of a program.

Programs can be developed in a variety of programming languages that support Win32API (e.g. Visual Basic and Visual C++).

- F&eIT setup utility automatically detects networked devices.
- Digital I/O, analog I/O, counters and GPIB modules are supported.
- Windows® XP/2000/Me/98/98 Second Edition are supported.
- Includes Visual Basic, Visual C++, Visual Studio.NET, Borland C++Builder and Borland Delphi sample programs.
- Supports I/O Assist Servers SVR-IOA(FIT)GY and SVR-IOA2(FIT)GY.







Online help

Sample program

Latest versions can be downloaded free from CONTEC's web site.

\* To develop applications in Linux, socket communication must be performed using F&eIT protocol.



#### Please open Page 13.

#### **Features**

#### Common

- Can control a maximum of 8 device modules (GPIB, COM excluded).
- · Drivers are the same as those for CONTEC's PCI Bus Boards which have the best compatibility with API-PAC(W32) drivers. [e.g. API-xxx(98/PC)W95/NT].

#### Digital I/O Driver

- · Digital input/output can be performed from the specified ports or bits.
- · Digital input changes can generate alarms via interrupts [not all modules support interrupts].
- Signal input noise can be prevented by using digital filter [digital filter not available on all modules].

#### Analog I/O Driver

- · Analog input / output range can be set by user.
- · Analog input / output can be performed from specified channels.
- · Input binary value can be converted to either voltage or current.

#### Counter Input Driver

- The mode can be chosen according to the input signal form [Single-phase / Two-phase / Single-phase with Gate Control].
- · Counter value can be input from specified channels.
- Counter value can be preset from specified channels.
- · Interrupts can be alarmed when a counter match occurs.

#### GPIB Communication Driver

- Can control up to 3 device modules (max).
- · IEEE-488 compliant.
- · IEEE-488.2 compliant commands.
- · Data Sending/Receiving, Command Sending, SRQ Receiving.

#### Temperature Input Driver

- Temperature or resistance value can be input from specified channels.
- Input value can be averaged according to the setting

#### Serial Communication Driver

- · Can control up to 3 device modules (max).
- · Needs Windows® standard Win32 API for serial communication.

#### **Specifications**

#### Supported OS

- CPU-SB303-FIT-36, CPU-SB22/256(FIT), CPU-SB21/256(FIT) Windows XP Embedded
- CPU-SB303-FIT

Windows XP Professional, Windows XP Embedded, Windows 2000 Professional

- CPU-SB20/256(FIT)GY, CPU-SB20/128(FIT)GY Windows 2000 Professional, Windows Me, Windows 98 Second Edition
- CPU-SB10/128(FIT)GY

Windows 98 Second Edition, Windows 98, Windows 95 OSR2, Windows NT Workstation Ver4.0

#### **Supported Programming Languages**

Visual C++ Ver2.0, 4.x, Ver5.0, Ver6.0 Visual Basic Ver4.0, Ver5.0, Ver6.0

#### Supported Device Modules

■ Analog I/O

ADI12-8(FIT)GY, ADI16-4(FIT)GY, DAI12-4(FIT)GY, DAI16-4(FIT)GY

DI-8(FIT)GY, DI-16(FIT)GY, DI-16H(FIT)GY, DI-32(FIT)GY, DO-8 (FIT)GY, DO-16(FIT)GY, DO-32(FIT)GY, DIO-4/4(FIT)GY, DIO-8/8 (FIT)GY, DIO-8/8H(FIT)GY, DIO-16/16(FIT)GY, DIO-8D(FIT)GY, RRY-4(FIT)GY

Counter

CNT24-2(FIT)GY, CNT16-8(FIT)GY, CNT16-8L(FIT)GY

**GPIB** Communication

GP-IB(FIT)GY Up to 3 devices (max)

- Temperature Input
  - PTI-4(FIT)GY Serial Communication

COM-2(FIT)GY, COM-1PD(FIT)GY

Interrupts: Invalid or 1 point per device module (3 points total)

#### **Features**

#### ● Common

- ·Initialization, setup and input/output is performed according to the set of device modules.
- · Utility available to set up all device modules.
- ·Setup value can be obtained by calling the function.

#### Digital I/O Driver

- · Digital input/output can be performed from the specified ports or bits.
- ·Signal input noise can be prevented by using digital filter [digital filter not available on all modules].

#### Analog I/O Driver

- ·Analog input / output range can be set by user.
- ·Analog input / output can be performed from specified channels [voltage or current].

#### Counter Input Driver

- ·The mode can be chosen according to the input signal form (Singlephase / Two-phase / Single-phase with Gate Control).
- ·Counter value can be input from specified channels.
- Counter value can be preset from specified channels.

#### Temperature Input Driver

- · Temperature or resistance value can be input from specified channels.
- Input value can be averaged according to the setting.

#### **Specifications**

#### **Supported OS**

Windows XP

Windows 2000 Professional

Windows Me

Windows 98 Second Edition

Windows 98

#### **Supported Programming Languages**

Visual C++ Ver5.0, Ver6.0 Visual Basic Ver5.0, Ver6.0 VisualStudio.NET (VB, VC, C#) Borland C++ Builder 5.0, 6.0 Borland Delphi 5.0, 6.0

#### Supported Device Modules -

Analog I/O

ADIT2-8(FIT)GY, ADIT6-4(FIT)GY, DAIT2-4(FIT)GY, DAIT6-4(FIT)GY

DI-8(FIT)GY, DI-16(FIT)GY, DI-16H(FIT)GY, DI-32(FIT)GY, DO-8 (FIT)GY, DO-16(FIT)GY, DO-32(FIT)GY, DIO-4/4(FIT)GY, DIO-8/8 (FIT)GY, DIO-8/8H(FIT)GY, DIO-16/16(FIT)GY, DIO-8D(FIT)GY, RRY-4(FIT)GY

CNT24-2(FIT)GY, CNT16-8(FIT)GY, CNT16-8L(FIT)GY

■ Temperature Input

PTI-4(FIT)GY

(\* COM, GPIB are used by Media Converter series)

**Interrupts:** Not supported

#### **Development Flow**

#### CPU-SB303-FIT-36 + API-SBP(W32)

Application development flow for CPU-SB303-FIT-36 + API-SBP(W32).

- ① A Connect a device module to the CPU-SB303-FIT-36 via the stack connector
  - B Install API-SBP(W32) runtime [Execution Environment]
  - C Use API-TOOL configuration [CONFIG.EXE] to set up the device module.

NOTE: Requires CD-ROM drive with USB interface or network CD-ROM / shared folder.

(2) When connected to an external device the status of such things as signal wires can be monitored with the Diagnosis Program.



Diagnosis Program

3 To develop program, install the API-SBP(W32) development environment on a PC. Online help and sample programs

are available for reference.



Online Help

Sample Program

4 Install developed program on CPU-SB303-FIT-36 using networked or USB floppy / cd-rom. Test and debug.

#### **Program Development**

#### API-SBP(W32)

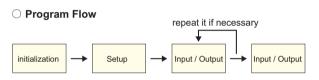
Procedure for using API-SBP(W32) library (DLL) follows.

#### OVisual Basic Example

- ① Add a standard module [APIxxx.BAS (xxx refers to DIO, AIO etc)] to the project.
- 2 Describe the function calls according to steps below.

#### ○ Visual C++ Example

- ① Install the header file [APIxxx.H (xxx refers to DIO, AIO, etc) to the source file.
- 2 Add library file [APIxxx.LIB [xxx refers to DIO, AIO, etc)] to the projects.
- ③ Describe the function calls according to steps below.
  - \* The following flow is used as a base pattern.



#### **Development Flow**

#### ●CPU-Caxx(FIT)GY + API-CAP(W32)

Application development flow for CPU-CAxx(FIT)GY + API-CAP(W32).

- ① Connect a device module to the CPU-CAxx(FIT)GY via the stack connector, plug in power supply.
- ② Install API-CAP(W32) development environment on a PC. Set up network settings [e.g. IP address, Sub network mask] using F&eIT setup utility [FITVIEW.EXE].
- 3 When connected to an external device the status of such things as signal wires can be monitored with the Diagnosis Program.



Diagnosis Monitor

4 Online help and sample programs are available for reference.



5 Test and debug can be done on PC.

#### **Program Development**

#### API-CAP(W32)

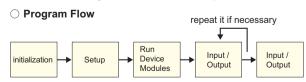
Procedure for using API-CAP(W32) library (DLL) follows.

#### O Visual Basic Example

- ① Add a standard module [CCAPxxx.BAS (xxx refers to DIO, AIO, etc)] to the projects.
- 2 Describe the function calls according to steps below.

#### O Visual C++ Example

- ① Install the header file [CCAPxxx.H (xxx refers to DIO, AIO, etc) to the source file.
- ② Add library file [CCAPxxx.H (xxx refers to DIO, AIO, etc)] to the projects.
- 3 Describe the function calls according to steps below.
  - \* The following flow is used as a base pattern.





### I/O Assist Server

#### Integrated management & Web monitoring of I/O Controller Unit





#### Management of I/O Controller

This server automatically and cyclically accesses up to eight I/O Controllers collecting I/O information. It then supplies the information to the host in a single communication, reducing line load.



#### **DDE Communication with Excel and SCADA (HMI) Software**

DDE and SuiteLink server FIT-SVR(W32) (included with controllers) enable communication to be controlled by software that supports DDE client functions such as Microsoft® Excel or

#### Bundled software (CD-ROM)

- · Windows® device module access library API - CAP(W32)[CD - ROM]
  - [Software] **P.13~1**
- · DDE, SuiteLink Server FIT-SVR(W32) Supported OS: Windows® XP/2000/NT40 (SP5 or upper)/Me/98
- · Utility software

For setting up nodes and updating firmware Supported OS: Windows® XP/2000/NT40 (SP5 or upper)/Me/98

No. or	Specification			
Item	SVR-IOA2(FIT)GY	SVR-IOA(FIT)GY		
CPU	SH4 240MHz SH3 100MHz			
Memory	Flash ROM:4Mbyte(32Mbit) SDRAM:32Mbyte(256Mbit) EDO	Flash ROM:1Mbyte(8Mbit) DRAM:2Mbyte(16Mbit)		
Interface (to host)	100BASE-TX / 10BASE-T I/F	100BASE-TX / 10BASE-T I/F		
Reponse Speed	Approx 1msec	Approx 2msec		
Power Voltage		e) located on the front Use of F&eIT Series y stabilizing power supply recommended		
Power Consumption	0.7A(max)	0.5A(max)		
FG Terminal	FG terminal equipped for the power input	connector		
Operating Temperature/Humidity	0 to 50°C, 10 to 90% RH (no condensation)			
Dimensions (mm)	25.2(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)			
Weight	100g			

This Server Unit remotely monitors and updates I/O information on a Web browser. It also collects I/O information by cyclically accessing Web servers and I/O Controller Units. Due to its simple design, development and implementation can be easily performed entirely on a Web browser.

#### **I/O Assist Server**

SVR-IOA2(FIT)GY (

SVR-IOA(FIT)GY



#### High-speed / advanced-functions: SVR-IOA2(FIT)GY

- 2 times faster than the previous model [SVR-IOA(FIT)GY] I/O and communication speed has been increased with the use of the SH4 240 MHz CPU. The communication speed is roughly doubled\* when used with the I/O Controller Module [CPU-CA20(FIT)GY].
  - \* Varies according to operating environment.
- High-speed / advanced-functions: SVR-IOA2(FIT)GY Web monitoring pages have been enhanced. Frames are now used for easier handling and viewing.

Power Supply is optional. [Power Supplies] F.11

#### Programless Web Monitoring

Provided with a Web server (Java applet) function, this unit assists with monitoring and updating I/O information from remote sites using a web browser. GUI components such as graphs, sliders and buttons (standard features) are user configurable on the viewing screen. All aspects of set-up can be completed via web browser - from design to implementation, from screen configuration to the linking of I/O information.

① Select GUI components from "Item" and place them in the screen



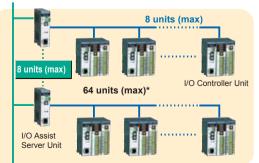


Monitoring & Control Server SVR-MMF2(FIT), with advanced functions is also available. In addition to Web monitoring, this model can achieve complete remote monitoring and control with arithmetic operations on input data, data output according to conditional branches, alarm notification by e-mail, logging and other features

[Monitoring & Control Server] =

#### Number of Units that can be installed

The SVR-IOAx(FIT)GY can coordinate and manage up to eight CPU-CAx(FIT)GYs. Up to eight SVR-IOAx(FIT)GYs can be installed within the same IP segment allowing a total of 64 CPU-CAx(FIT)GYs in the same installation.



\* Number of installed CPU-CAx(FIT)GYs when eight SVR-IOAx(FIT)GYs are installed.

### **Monitoring & Control Server**

### Remote monitoring and control of F&eIT and PLCs - No programming needed



#### Manual and Sample Program Included

- Manual and sample program can be found on the included CD.
- Monitoring samples / Task programming samples can be uploaded to SVR-MMF2(FIT)



Installation on DIN rail

#### **Web Monitoring**

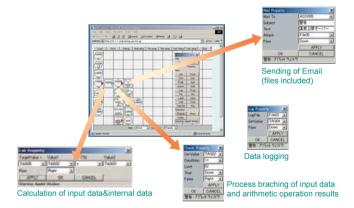
Preloaded with a Web server (Java applet) function, the SVR-MMF (FIT)GY enables monitoring and updating of I/O information from remote sites using

a web browser. GUI components(such as graphs, sliders and buttons) and imported image data can be user formatted on the display. All aspects of setup, from screen configuration to linking with the I/O information can be completed using a web browser.



#### Web Task Script

By combining such tasks as arithmetic operation, conditional branches, data output, e-mail transmission and data logging, execution processes and tasks can be set up much like a flowchart. All steps can be completed using a Web browser.



#### Wide Range of Supported Devices

- · Up to eight device modules can be stacked.
- · I/O Controllers and I/O Assist Servers can be linked over the network.
- · The unit can be linked to PLCs on the network or connected by the RS-232C serial interface

#### Message Communication Function

- · Up to four serial communication devices [COM-2(FIT)GY or COM-1PD(FIT) GY] can be stacked. (RS-232C supports 8 ports, RS-422A supports 4 ports)
- · Up to 10 links can be connected when using serial communication and Ethernet (TCP/UDP) devices.
- Communication is set up using Web task script.

This programmable Server Unit is provided with multiple functions including a Web server that can remotely monitor and update I/O information as well as task scripting, logging and e-mail transmission. Designed for easy operation and development through web browser.

#### **Monitoring & Control Server Unit**

#### SVR-MMF2(FIT) (6

Power Supply Optional. [Power Supplies] P.1

	Item	Specification
CPU		SH-4 240MHz
Momor	,	Flash ROM: 8Mbyte (64Mbit)
Memor	у	SDRAM: 64Mbyte (512Mbit)
LAN	I/F	Ethernet 100BASE-TX/10BASE-T RJ-45 connector
	Controller	[National Semiconductor] 10/100BASE-TX controller DP83815 Sending: 2Kbyte, Receiving: 2Kbye, built in Buffer Full-Duplex compliant
F&eIT I	/F	F&eIT stacking interface
Connec	table devices	8 units (max) *1
NA - ded -		Direct connection from side and fixed with equipped locking system.
Module connection method		Includes all connecting parts
RTC		Lithium backup battery life: 10 years or more at 25°C Real time clock precision error: within ±1 minutes per month
Rated input voltage		5VDC ±5%; 2-piece power input connector (removable) located on the front; Use of F&eIT Series dedicated power supplies or third-party stabilizing power supply recommended
Power Consumption		0.5A (max) *2 (Exclusive of the current comsumption to device units)
FG terminal		FG terminal equipped for the power input connector
Dimensions (mm)		25.2(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)
Weight		100g

Monitoring 8

- \*1: The total maximum power consumption by each module can not exceed the rated output
- current of the power supply unit.

  \*2: The stack connector supplies the power to each device module. Supplied power can not exceed the permissible current of a stack connector (max 3.0A).

### **Supported PLCs**

#### Mitsubishi Co., Ltd.

- · MELSEC-Q series
- · MELSEC-A series
- · MELSEC-QnA series

Omron Co., Ltd.

· SYSMAC-CS/CJ series Yokogawa Co., Ltd.

· FA-M3 series

#### Siemens Co., Ltd.

- · SIMATIC S7-300 series
- · SIMATIC S7-400 series

#### **Rockwell Automation (Japan)** Co., Ltd.

· Compact Logix series

#### e-mail Transmission

The e-mail transmission function allows alarm information or stored files to be sent to the administrator.

#### e-mail Reception

Tasks can be confirmed via e-mail.

#### **PPP Server Dial-up Connection**

Operation and data transfer can be done over PSTN network from an external host by utilizing the PPP server function. Dial-up function allows this unit to access the internet.

#### **SNMP Agent**

SNMP agent function provides integrated management by using network management software.



## **Security Server Unit**

### OUltra-compact, Easy-handling Firewall Router for Embedded Use





Installation on DIN rail

#### **Firewall Function**

Security Server prevents unauthorized outside access.

#### **Port Forward Function**

By dividing up the host that performs data transmission according to individual applications, concentrated communication loads can be distributed as needed.

**Configuration Example** Unauthorized outside access is prevented by setting communication permissions on each port. **External Network** (Worldwide Zone) DMZ (Demilitarized Monitoring & Control Server Internal Network (Safety Zone) I/O Assist Switching Hub I/O Controller I/O Controller Sensor Sensor Sensor

This ultra-compact and easy-handling firewall router, designed for embedded use, prevents illegal offsite access. This router is suited for use not only with the F&eIT Series but also to provide virtual segmentation of PLCs and other industrial equipment or to provide Internet access to your network.

#### **Security Server Unit**

SVR-SEC(FIT)GY CE

Power Supply Unit is optional. [Power Supply] P.1

#### **NAT (Address Translation) Function**

The Security Server is provided with a port address translation function from private addresses to a single public address to ensure protection from illegal accessing.

#### Simple Setting

Various security settings can be set up easily on a Web browser.

Item		Specification
Interface	Ethernet Port (WAN,LAN1,LAN2)	100BASE-TX/10BASE-T RJ-45 connector ×3
	Serial Port (PPP)	RS-232C 9-pin D-sub connector × 1
Internet Conne	ction Function	Ethernet port (DHCP or fixed IP), dial-up (serial port)
NAT Filter Fun	ction	Designated phase, IP address/mask, protocol, port number and interface
Port Forward F	unction	Designate IP address, protocol, and port number
Administrative Functions		DHCP client (WAN side), DHCP server (LAN side), Administrative Functions PPP server (serial port), SNMP agent, backup/restore of configuration information
Routing Functi	on	Internal network, external network, routing of DMZ
Prevention of U	nauthorized Operation	Management by user name and password
Monitoring Fur	iction	Refer to logs on Web browser
VPN Function		None
Number of Acc	essible Local PCs	Unlimited
Max.Number of Simultaneous Sessions		Max. 9000
Supported Protocol		TCP-IP/UDP-IP (protocol can be registered)
Dimensions (mm)		52.4(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)
Power Consun	nption	5VDC±5% 1.5A
Weight		200g

	Condition		Requirement
suc	Operating Temperature		0° to 50°C
Specifications	Storage Ter	nperature	-10° to 60°C
ecifi	Operating humidity		10 to 90% RH (no condensation)
			Normal
nen	Corrosive Gas		Not allowed
Environment	Noise Resistance	Line Noise	AC line/2 kV, signal line/1 kV (IEC1000-4-4Level 3,EN61000-4-4Level 3)
E	☐ Grouding		D type (former Class 3)

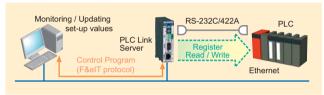
### **PLC Link Server**

### O For monitoring & updating remote PLCs via Intranet / Internet



The SVR-PLCLx(FIT)GY can monitor and update the internal register information of PLCs from any computer on the network. It can also monitor the status of remote PLCs and update their setup via intranet or internet.





#### Supported PLCs

#### PLC for Mitsubishi [MELSEC-Q series]

Link unit Q	QJ71C24 (Supported protocol: 4C Frae, form 4) QJ71C24-R2 (Supported protocol: 4C Frae, form 4)
CPU unit Q	Q00, Q00J, Q01, Q02, Q02H, Q06H, Q12H, Q25H

Security Server

PLC Link Server

### Media Converters

- ©Easily extend communication distance and configure wireless networks
- RS-232 / RS-422 serial communication protocol is converted to wired or wireless LAN.
- Choice of three operation modes to suit your specific needs.

#### Serial ⇔ Ethernet







**RS-232C Media Converter (Wired LAN)** 

RP-COM(FIT)H

10-30VDC Type

(€

RP-COM(FIT)H-AF 5VDC / Power-over-Ethernet Type

CE

Windows Driver AC Adapter

· [RP-COM(FIT)H]

Voltage range: 10~30VDC standard power supplies.

· [RP-COM(FIT)H-AF].

IEEE802.3AF-compliant device. Power can be supplied via LAN cable.

- · COM-2(FIT)GY and COM-1PD(FIT)GY can be interconnected via stack connectors up to 3 devices (max)
- · DHCP Client function.

#### **RS-422A Media Converter (Wired LAN)**

RP-422(FIT)GY (

Windows Driver (AC Adapter)



Serial⇔Wireless LAN



FX-DS540-COM2 (Currently this model can be used in Japan only.)

Windows Driver (AC Adapter)





### **RS-422A Media Converter (Wireless LAN)**

FX-DS540-422 (Currently this model can be used in Japan only.)

Windows Driver (AC Adapter)

[Device Modules] P.08~11

[Power Supplies] P.11

### **GPIB Communication Media Converter**

#### **GPIB** ⇔ Ethernet



- GPIB communication protocol is converted to Ethernet.
- GPIB communication devices can be remote -controlled on a Windows®PC over Ethernet.
- Unconstrained by GPIB standards, communication can be extended up to the maximum length allowed

#### RP-GPIB(FIT)GY (

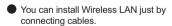


\* The AC adapter provided is for 100 VAC only. To use in a DC power environment, use the DC-DC Power Supply Unit (sold separately).

Windows Driver (AC Adapter)

#### **Wireless Access Point / Station**





<u>IEEE</u>802.11a 

IEEE802.11b/g FX-DS540-APDL2

IEEE802.11a

IEEE802.11b/g FX-DS540-STDL2

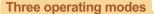
J52 W52 W53

- Devices with a wired Ethernet communication port can be converted to wireless - independent of OS or protocol.
- · The unit can be used as an access point for small-scale wireless LAN systems
- · A UTP cable power supply (sold separately) is available.



Please see the next page for the Media Converters' specifications and software.



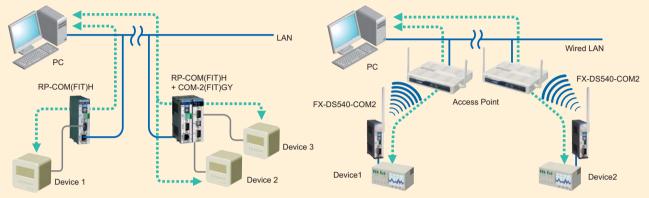






In a Windows® environment Virtual COM Mode allows the device to function as a standard COM port. When connected via Ethernet, remote devices can be operated as if they were directly connected to PC. Also supports access via socket communication.

#### You can add or expand PC COM ports by connecting wired / wireless LAN.

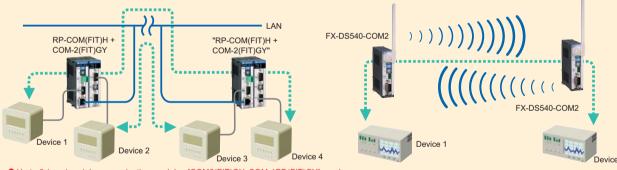


- Serial communication modules [COM-2(FIT)GY, COM-1PD(FIT)GY] can be connected up to 3 devices (max)
- Devices also support the ad-hoc mode that utilize access points.

#### **Convert your Serial connection Transparent Mode**

In Transparent Mode data from connected devices is transferred as it is. Serial cables can be replaced with ethernet cables without changing communication software settings. Up to 254 (max) devices can be installed in the same system.

#### No re-configuration of hardware or software are required.



- Up to 3 (max) serial communication modules [COM2(FIT)GY, COM-1PD(FIT)GY] can be connected via stack connectors.
   Devices connected via a stack connector can not communicate with each other. [For example, in the above diagram, Device 1 can ONLY communicate with Device 3 or Device 4 NOT Device 2. As drawn, Device 1 is communicating with Device 4 and Device 2 is communicating with Device 3.]
- Devices also support the infrastructure mode without the need for

N-to-N packet communication using dedicated commands

Modem Mode

This mode is used for creating communication programs and conducting packet communications using dedicated commands. You can conduct communications to multiple units (N-to-N) by appending packets with the device ID. 254 units can be installed on the same line.

- Producing programs for control, communicating with several devices of the same type.

  Serial communication modules [COM-2(FIT)GY,
- COM-1PD(FIT)GY] can be connected 3 devices (max) with stack connectors.

### Media Converter Options [RP-COM(FIT)H, RP-COM(FIT)H-AF]

#### **Serial Communication Modules**

COM-2(FIT)GY RS-232C 2ch

RS422A/485 1ch COM-1PD(FIT)GY







#### **AC Adapter Power Supplies**

12VDC, 1A output [for RP-COM(FIT)H] POA201-10

POA200-20 5VDC, 2A output [for RP-COM(FIT)H-AF]

#### PoE Power Supplies [RP-COM(FIT)H-AF]

Power Supply with UTP Cable POW-CB30(af)

Multi-port (4) Power Supply HUB POW-CBM4(af)



### **Media Converters**

#### **Serial** ⇔ **Ethernet**

#### **Media Converter**

Model		RP-COM(FIT)H	RP-COM(FIT)H-AF	RP-COM(FIT)GY
	Standard	RS-232C		
Serial	Data Speed	300~921,600bps		
	Connector	9-pin D-sub M (male type)		
Wire LAN	Standard	IEEE802.3 (10BASE-T) / IEEE802.3u (100BASE-TX)	IEEE802.3 (10BASE-T) / IEEE802.3u (100BASE-TX) / IEEE802.3af (PoE)	IEEE802.3 (10BASE-T) / IEEE802.3u (100BASE-TX)
	Data Speed	10/100Mbps		
	Access Mode	CSMA/CD		
	Transmission Format	Half Duplex / Full Duplex		
	Available Ports	1 (10BASE-T / 100BASE-TX)		
Power Supply	·	10 to 30 VDC ±5% (AC Adapter purchased separately)	5VDC ±5% (AC Adapter purchased separately)	5VDC ±5% (AC Adapter included)
Power Consumption		12VDC 0.2A, 24VDC 0.1A	0.4A (max)	0.5A (max)
Expansion Module		RS-232C 2ch add-on: COM-2(FIT)G RS-422A/485 1ch add-on: COM-1P Up to 3 (max) COM-2(FIT)GY or COM-	D(FIT)GY	-
Dimensions (mm)		25.2(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)		
Weight		100g		

#### Serial ⇔ Wireless LAN

#### **Media Converter**

Weight		100g		
Model		FX-DS540-COM2	FX-DS540-422	
Serial	Standard	RS-232C	RS-422A	
	Data Speed	300~921,600bps		
	Connector	9-pin D-sub M (male type)		
Standard		IEEE802.11a-compliant OFDM (Orthogonal Frequency Division Multiplexing) method		
Channels	Channels	12ch (34,38,42,46ch[J53]; 36,40,44,48ch[W52];	, ,,	
		52,56,60,64ch[W53])	4ch (32, 38, 42, 46)	
Wireless LAN	Data Speed *1	54, 48, 36, 24, 18, 12, 9, 6Mbps (Auto/Fixed)		
IEEE802.11a	Access Mode	CSMA/CA + ACK (RTS/CTS)		
IEEE0UZ.IIA	Wireless LAN category	Low-power Data Transmission System (5.150~5.350G	Hz)	
	Aerial Power	10Mw/MHz or less		
	Security	WEP, WPA(AES,TKIP), WPA-PSK(AES,TKIP),		
		WSLfcan be used simultaneouslyl:	WEP (64/128/152Bit) or AES (128Bit)/WSL	
		IEEE802.1X	(Original Code) [can be used simultaneously]	
	Standard	IEEE802.11b-compliant DSSS (Direct Sequence Sprea	ad Chaotrum) mothod	
	Channels	14ch (1~14)	ad Opecitum) method	
	Data Speed *1	11, 5.5, 2, 1Mbps (Auto/Fixed)		
	Access Mode	CSMA/CA + ACK (RTS/CTS)		
Wireless LAN	Wireless LAN category	Low-power Data Transmission System (2.4~2.497GHz)		
IEEE802.11b	Aerial Power	10Mw/MHz or less		
	Security	WEP, WPA(AES,TKIP), WPA-PSK(AES,TKIP),		
		WSL[can be used simultaneously];	WEP (64/128/152Bit) or AES (128Bit)/WSL	
		IEEE802.1X	(Original Code) [can be used simultaneously]	
			Bill Mark III	
	Standard	IEEE802.11a-compliant OFDM (Orthogonal Frequency	Division Multiplexing) method	
	Channels Data Speed *1	13ch (1~13)		
		54, 48, 36, 24, 18, 12, 9, 6Mbps (Auto/Fixed)		
	Access Mode Wireless LAN category	CSMA/CA + ACK (RTS/CTS)		
Wireless LAN		Low-power Data Transmission System (2.4~2.835GHz	)	
IEEE802.11g	Aerial Power	10Mw/MHz or less		
	Security	WEP, WPA(AES,TKIP), WPA-PSK(AES,TKIP),	WEP (64/128/152Bit) or AES (128Bit)/WSL	
		WSL[can be used simultaneously];	(Original Code) [can be used simultaneously]	
		IEEE802.1X	(Original Code) [can be ased simultaneously]	
		RS-232C 2ch add-on: COM-2(FIT)GY		
Expansion Module		RS-422A/485 1ch add-on: COM-1PD(FIT)GY	-	
		Up to 3 (max) COM-2(FIT)GY or COM-1PD(FIT)GY		
		can be interconnected		
Dimensions (mm)		25.2(W) × 64.7(D) × 94.0(H)(Exclusive of protrusions)	81(W) × 26.5(D) × 175(H)	
· '			. , , , , , , , , , , , , , , , , , , ,	
Weight		110g	200g	

<sup>\*1:</sup> Represents Wireless LAN specifications, not actual data speed

#### **GPIB** ⇔ Ethernet

#### **Media Converter**

The representation of the content of			
Model		RP-GPIB(FIT)GY	
GPIB	Standard	IEEE-488.1, IEEE-488.2	
	Mode	Master Mode only	
	Number of channels	1ch	
	Data Speed	Sending: 18Kbyte/sec, Receiving: 10Kbyte/sec	
	Data type	8 parallel lines, 3 handshake lines	
	Signal Logic	Negative Logic: <l level=""> 0.8V or less, <h level=""> 2.0V or more</h></l>	
Wire LAN	Standard	IEEE-802.3 (10BASE-T)	
	Data Speed	10Mbps	
	Access Mode	CSMA/CD	
	Transmission Format	Half Duplex / Full Duplex	
	Available Ports	1 (10BASE-T / 100BASE-TX)	
Power Supply		5VDC ±5% (AC Adapter included)	
Power Consumption		0.6A (Max.)	
Dimensions (mm)		50.4(W) × 64.7(D) × 94.0(H) (Exclusive of protrusions)	
Weight		190g	

#### Wired ⇔ Wireless LAN

#### **Media Converter**

Weight   190g		
Model		FX-DS540-COM2 FX-DS540-422
Wired LAN	Standard	IEEE802.3 (10BASE-T) / IEEE802.3u (100BASE-TX)
	Data Speed	10/100Mbps
	Access Mode	CSMA/CD
	Transmission Format	Half Duplex / Full Duplex
	Available Ports	1 (10BASE-T / 100BASE-TX)
Wireless LAN	Standard	IEEE802.11a-compliant OFDM (Orthogonal Frequency Division Multiplexing) method
IEEE802.11a	Channels	8ch (36,40,44,48ch[W52]; 52,56,60,64ch[W53]) 12ch (34,38,42,46ch[J53]; 36,40,44,48ch[W52]; 52,56,60,64ch[W53]
	Data Speed *1	54, 48, 36, 24, 18, 12, 9, 6Mbps (Auto/Fixed)
	Wireless LAN category	Low-power Data Transmission System (5.150~5.350GHz)
Wireless LAN	Standard	IEEE802.11b-compliant DSSS (Direct Sequence Spread Spectrum) method
IEEE802.11b	Channels	14ch (1~14)
	Data Speed *1	11, 5.5, 2, 1Mbps (Auto/Fixed)
	Wireless LAN category	Low-power Data Transmission System (2.4~2.497GHz)
Wireless LAN	Standard	IEEE802.11a-compliant OFDM (Orthogonal Frequency Division Multiplexing) method
IEEE802.11g	Channels	13ch (1~13)
	Data Speed *1	54, 48, 36, 24, 18, 12, 9, 6Mbps (Auto/Fixed)
	Wireless LAN category	Low-power Data Transmission System (2.4~2.4835GHz)
Common to all	Access Mode	CSMA/CA + ACK (RTS/CTS)
Wireless LAN	Aerial Power	10Mw/MHz or less
	Security	WEP(64/128/512Bit), WPA(AES)(128Bit), WPA(TKIP)(256Bit), AES-OCB(128Bit) / WSL(Original Code) [can be used simultaneously], MAC Address filter link *2, IEEE802.1X supplicant *3
Dimensions (mm)		81(W) × 26.5(D) × 175(H)
Weight		200g
	I ANIifititt-	** FV POT40 APRI 0 *** FV POT40 APRI 0 ****

<sup>\*1:</sup> Represents Wireless LAN specifications, not actual data speed.

<sup>\*2:</sup> FX-DS540-APDL2 only. \*3: FX-DS540-STDL2 only.

### **Media Converter Software**

#### Software for Serial Communication Media Converter

#### Included on CD-ROM

Utility programs on disk include device setup and virtual COM port drivers for Windows®

To address specific application needs the Serial Communication Media Converters can operate in 3 different modes.

#### [Virtual COM Mode]

- When operating in a Windows® environment, the included COM port drivers allow CONTEC's Serial Communication Media Converters to be used as standard COM ports.
- 32 ports (max) can be added via Serial Communication Media Co-
- Device supports Windows® standard Win32 API Communication Functions such as CreatFile(), WriteFile(), ReadFile(), SetCommState(), etc.

#### [Modem Mode]

- Mode has a CONTEC designed protocol that uses modem command.
- Can send or receive data from all Serial Communication Media Converter devices that are installed in the system through the host PCs onboard COM
- Communication can be conducted to multiple units (N-to-N) by appending packets with the device ID.

#### [Transparent Mode]

- By connecting two Serial Communication Media Converter modules, the length of the RS-232C LAN -> RS-232C cables can be extended
- When an RP422(FIT)GY and FX-DS540-422 are assembled as a set they can be used as an RS-232C-422 level converter.

Latest version can be downloaded from CONTEC's website.

#### **Features**

- Allows user to extend cable length, add standard serial port and save on serial communication wiring
- COM port number can be changed via communication application when used as a standard COM port [Virtual COM Mode].
- Offers both Hardware Overflow Control (such as RTS / CTS) and Software Flow Control (XON / XOFF).
- Systems can be configured using the wireless COM device.
- Monitoring of device setup status and board operation status supports SNMP agent and MIB.

#### **Specifications**

#### Supported OS

#### Virtual COM Mode **Modem Mode**

- · All OS

- Windows Vista WindowsXP Windows 2000 Windows me
- Windows 98
- When operating in a Windows® environment Virtual Mode setup uses UDP protocol and COM drivers available for download from CONTEC's website. This software can also be used with any environment that utilizes API communication.

#### **Supported Hardware**

Wired Devices

RP-COM(FIT)H, RP-COM(FIT)H-AF, RP-422(FIT)GY Wireless Devices

FX-DS540-COM2, FX-DS540-422

### Software for RP-GPIB(FIT)GY [API-RPGIB(W32)

#### Included on CD-ROM

**Transparent Mode** 

All OS

The driver software is used for the control of CONTEC GPIB Communication Media Converter Series when used in a Windows® environment.

This software can be used with programming languages the support Win32 API

functions (such as Visual Basic, Visual C++) giving the end-user sufficient options to create a program for their unique application.

Latest version can be downloaded from CONTEC's website.

#### **Features**

- GPIB controller is IEEE-488 and IEEE-488.2 compliant.
- Setup is done via software.
- 3-line handshake ensures reliable data transfer between devices with different rates.
- IConversion of GPIB signal to LAN eliminates the cabling length restrictions
- Up to 4 devices (max) can be used in the same system.
  - \*1: Slave Mode is not supported

#### **Specifications**

#### Supported OS

- Windows Vista
- · Windows XP
- Windows Me
- · Windows 2000
- Windows 98
  - \* The software also supports a english version.

#### Supported Languages

· Visual C++ 6.0 Visual Basic 6.0

#### Supported Hardware -

RP-GPIB(FIT)GY



# From Factory Floor to Corporate Offices, CONTEC Provides Integrated Solutions with Expanding Potential.

The broadly spread of the Internet has resulted in networks springing up in a wide range of fields. This, in turn, has resulted in the appearance of many information devices that make use of this infrastructure. Yet, it is a fact that interconnectivity - the greatest advantage of networks - is not being used to its fullest. CONTEC sees networks as a prime part of the system bus concept and has developed distributed monitor & control networks that organically integrate various applications from corporate offices through to field applications.



# Compilation of CONTEC

Over the years, CONTEC has developed products in the fields of industrial computers, instrumentation/control components and computer networks.

The F&elT Series fully incorporates CONTEC's expertise, achieving the essential features of speed, reliability, maintenance and energy savings in industrial systems.

#### **Industrial PC Works**





# Equipped with 35 mm DIN Rail Mounting Mechanism

F&eIT Series components are equipped with a mechanism for mounting onto general-purpose 35 mm DIN rail.

As a result, they can be easily placed into a control panel or mounted on a case. They can

on a case. They can also be mounted on and removed from a DIN rail using only a flathead screwdriver.

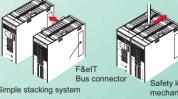




# F&eIT Bus - Simple Stacking Method Eliminates the Need for a Backplane

This simple stacking mechanism requires no backplane and allows for easy expansion of I/O interfaces for I/O Controller Modules or Micro Controller Units.F&eIT

Bus also uses a secure design with a safety lock to prevent accidental disconnection.



# Programless Web Remote Monitoring and Control

The I/O Assist Server and Monitoring & Control Server are provided with a Web server function that can be configured using standard GUI parts. This allows you to configure a remote monitoring/control system that uses a Web browser without the aid of a program.



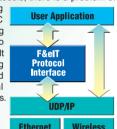
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# Technology

#### Ideal Network Protocol - "F&eIT Protocol"

"F&eIT Protocol" is an original communication protocol used with Contec's UDP/IP-based F&eIT Series."UDP/IP" is often used in combination with TCP/IP, and requires simpler communication procedures. This high-speed protocol is ideally suited for use in networks that require realtime operation. However, with connectionless protocols, there is a problem of

reliability since arrival of incoming data is not confirmed. CONTEC has resolved this problem by adding a response confirmation process to the upper layer of UDP/IP. The result is the "F&eIT Protocol" featuring speed, real-time operation and reliability; proving to be an ideal protocol for industrial device networks.



### Open Architecture

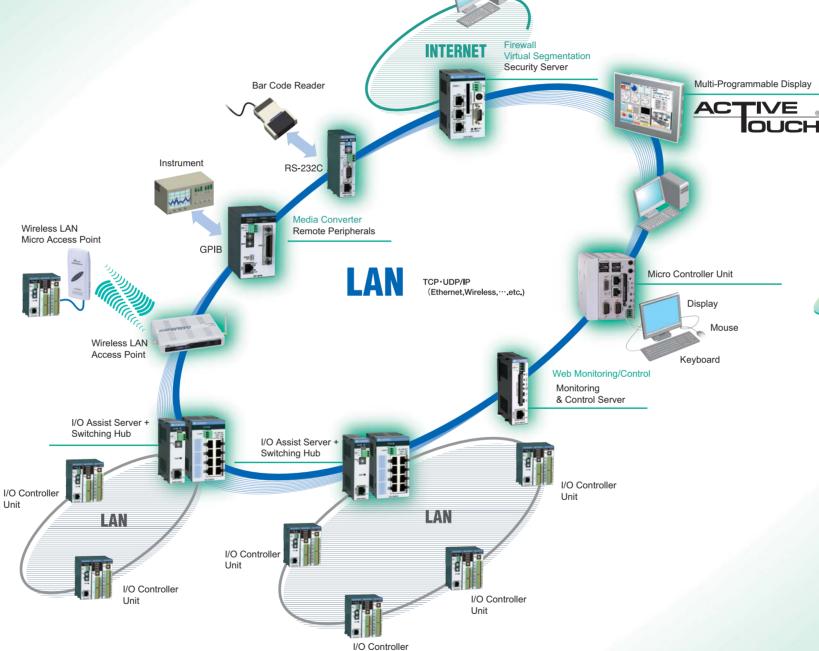
As an open architecture, F&eIT protocol enables compatible units to be controlled not only by dedicated Win32API functions but also general-purpose socket functions on other operating systems. F&eIT Bus, the system bus that establishes the connection between device modules is also based on an open architecture. It allows users to develop their own original device modules.

### Stable Cyclic Time

Data collisions and delays in Ethernet communication are a bottleneck for the real-time operation that is required in industrial networks. CONTEC's high-speed switching technology solves this problem. For example, packets sent from multiple I/O Controller

Units will be routed at high speed by the internal bus on the switching hub before they are transferred to an I/O AssistServer or other target node. The result is a short and stable cyclic time with no data collisions.





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